

LINEAR SYSTEMS

Twenty-Five Years Of Quality Through Innovation

2N/PN/SST4391 SERIES

SINGLE N-CANNEL JFET SWITCH

FEATURES

Replacement for Siliconix 2N/PN/SST4391, 4292, & 4393

LOW ON RESISTANCE $r_{DS(on)} \leq 30\Omega$

FAST SWITCHING $t_{ON} \leq 15ns$

ABSOLUTE MAXIMUM RATINGS¹

@ 25 °C (unless otherwise stated)

Maximum Temperatures

Storage Temperature (2N) -65 to 200°C

Storage Temperature (PN/SST) -55 to 150°C

Junction Operating Temperature (2N) -55 to 200°C

Junction Operating Temperature (PN/SST) -55 to 150°C

Maximum Power Dissipation

Continuous Power Dissipation (2N) @ Tc=25°C 1800mW³

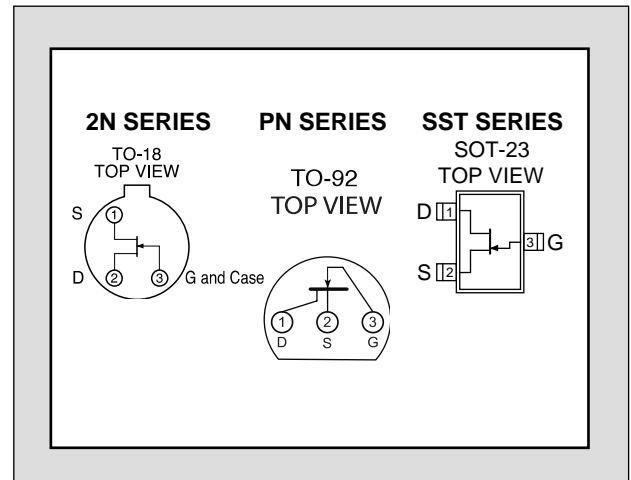
Continuous Power Dissipation (PN/SST) 350mW⁴

Maximum Currents

Gate Current 50mA

Maximum Voltages

Gate to Drain or Source (2N/PN) -40V



STATIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC	TYP	4391		4392		4393		UNIT	CONDITIONS
			MIN	MAX	MIN	MAX	MIN	MAX		
BV _{GSS}	Gate to Source Breakdown Voltage	2N/PN/SST	-40		-40		-40		V	I _G = -1μA, V _{DS} = 0V
V _{GS(off)}	Gate to Source Cutoff Voltage	2N/PN	-4	-10	-2	-5	-0.5	-3		V _{DS} = 20V, I _D = 1nA
		SST	-4	-10	-2	-5	-0.5	-3		V _{DS} = 15V, I _D = 10nA
V _{GS(F)}	Gate to Source Forward Voltage	0.7		1		1		1		I _G = 1mA, V _{DS} = 0V
V _{DS(on)}	Drain to Source On Voltage	0.25						0.4		V _{GS} = 0V, I _D = 3mA
		0.3			0.4					V _{GS} = 0V, I _D = 6mA
		0.35		0.4					V _{GS} = 0V, I _D = 12mA	
I _{DSS}	Drain to Source Saturation Current ²	2N	50	165	25	150	5	125	mA	V _{DS} = 20V, V _{GS} = 0V
		PN	50	165	25	150	5	125		
		SST	50		25		5			
I _{GSS}	Gate Leakage Current	2N/SST	-5	-100		-100		-100	pA	V _{GS} = -20V, V _{DS} = 0V
		PN	-5	-1000		-1000		-1000		
I _G	Gate Operating Current		-5							V _{DG} = 15V, I _D = 10mA

STATIC ELECTRICAL CHARACTERISTICS CONT. @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC		TYP	4391		4392		4393		UNIT	CONDITIONS	
				MIN	MAX	MIN	MAX	MIN	MAX			
I _{D(off)}	Drain Cutoff Current	2N	5						100	pA	V _{DS} = 20V, V _{GS} = -5V	
			5				100				V _{DS} = 20V, V _{GS} = -7V	
			5		100						V _{DS} = 20V, V _{GS} = -12V	
		PN	5						1000			V _{DS} = 20V, V _{GS} = -5V
			5					1000				V _{DS} = 20V, V _{GS} = -7V
			5		1000							V _{DS} = 20V, V _{GS} = -12V
		SST	5		100		100		100			V _{DS} = 10V, V _{GS} = -12V
r _{DS(on)}	Drain to Source On Resistance				30		60		100	Ω	V _{GS} = 0V, I _D = 1mA	

DYNAMIC ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC		TYP	4391		4392		4393		UNIT	CONDITIONS
				MIN	MAX	MIN	MAX	MIN	MAX		
g _{fs}	Forward Transconductance		6							mS	V _{DS} = 20V, I _D = 1mA f = 1kHz
g _{os}	Output Conductance		25							μS	
r _{DS(on)}	Drain to Source On Resistance				30		60		100	Ω	V _{GS} = 0V, I _D = 1mA
C _{iss}	Input Capacitance	2N	12		14		14		14	pF	V _{DS} = 20V, V _{GS} = 0V f = 1MHz
		PN	12		16		16		16		
		SST	13								
C _{rss}	Reverse Transfer Capacitance	2N	3.3						3.5	pF	V _{DS} = 0V, V _{GS} = -5V f = 1MHz
		PN	3.5						5		
		SST	3.6								
		2N	3.2				3.5				V _{DS} = 0V, V _{GS} = -7V f = 1MHz
		PN	3.4				5				
		SST	3.5								
		2N	2.8		3.5						
PN	3.0		5								
SST	3.1										
e _n	Equivalent Input Noise Voltage		3							nV/√Hz	V _{DS} = 10V, I _D = 10mA f = 1kHz

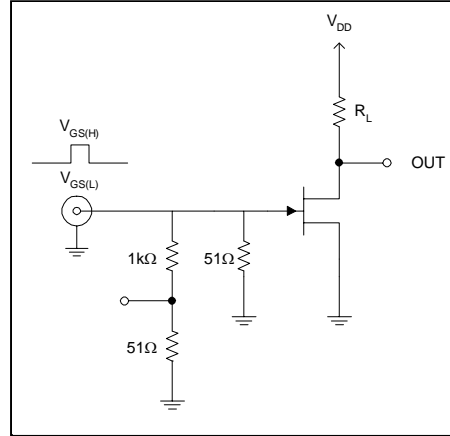
SWITCHING ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYM.	CHARACTERISTIC		TYP	4391		4392		4393		UNIT	CONDITIONS
				MIN	MAX	MIN	MAX	MIN	MAX		
t _{d(on)}	Turn On Time	2N/PN	2		15		15		15	ns	V _{DD} = 10V, V _{GS(H)} = 0V
t _r		SST	2								
		2N/PN	2		5		5		5		
t _{d(off)}		SST	2								
	2N/PN	6		20		35		50			
t _f	2N/PN	13		15		20		30			
	SST	13									

SWITCHING CIRCUIT CHARACTERISTICS

SYM.	4391	4392	4393
$V_{GS(L)}$	-12V	-7V	-5V
R_L	800 Ω	1600 Ω	3200 Ω
$I_{D(on)}$	12mA	6mA	3mA

SWITCHING TEST CIRCUIT



TO-18 *

Three Lead

TO-92 *

SOT-23

DIMENSIONS IN MILLIMETERS

*Dimensions in inches

NOTES

1. Absolute maximum ratings are limiting values above which serviceability may be impaired.
2. Pulse test: $PW \leq 300\mu s$, Duty Cycle $\leq 3\%$
3. Derate 10mW/°C above 25°C
4. Derate 2.8mW/°C above 25°C

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